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(54) **METHODS AND APPARATUSES FOR INTERFACING MICROWAVE CIRCUITS**

(71) Applicant: **The Government of the United States, as represented by the Secretary of the Navy**, Arlington, VA (US)

(72) Inventors: **Thomas Petelik**, Alexandria, VA (US); **Steven Bode**, Alexandria, VA (US); **Matthew Anderson**, Hanover, MD (US)

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(57) **ABSTRACT**

An apparatus for interfacing with an RF/microwave subsystem is provided. The apparatus includes a printed circuit board that includes: a controller, and a connector constructed to provide control signals and power signals to a subsystem in accordance with instructions from the controller, and a mechanical interface constructed to provide a mechanical connection between the subsystem and the printed circuit board.